OSRAM LY H9PP Datasheet

Discontinued

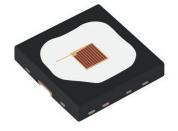




OSLON® Black Flat

LY H9PP

OSLON Black Flat is a new small size high-flux LED for slim designs. The black package stands for high stability.





Applications

- Static Forward Lighting

Features

- Package: SMD epoxy package

- Chip technology: Thinfilm

- Typ. Radiation: 120° (Lambertian emitter)

- Color: λ_{dom} = 590 nm (• yellow)

- Corrosion Robustness Class: 3B

- Qualifications: AEC-Q102 Qualified

- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)



Orc	dering	ı Info	rmation
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Type Luminous Flux $^{1)}$ Ordering Code $I_{\scriptscriptstyle F} = 350~{\rm mA}$

 φ^{\wedge}

LY H9PP-HZKX-46-1 39 ... 82 lm Q65111A7406

Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min.	-40 °C
		max.	125 °C
Storage Temperature	T _{stg}	min.	-40 °C
	-19	max.	125 °C
Junction Temperature	T _j	max.	150 °C
Junction Temperature for short time applications*	T_{j}	max.	175 °C
Forward current	I _F	min.	20 mA
$T_S = 25 ^{\circ}C$	·	max.	1000 mA
Surge current	I _{FS}	max.	2500 mA
$t \le 10 \ \mu s; \ D = 0.005 \ ; \ T_{_{\rm S}} = 25 \ ^{\circ}{\rm C}$	10		
ESD withstand voltage	V_{ESD}		8 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	LOD		
Reverse current 2)	I _R	max.	200 mA

^{*} The median lifetime (L70/B50) for Tj = 175° C is 100h.

Characteristics

 $I_F = 350 \text{ mA}; T_S = 25 \text{ }^{\circ}\text{C}$

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{\sf peak}$	typ.	597 nm
Dominant Wavelength 3)	$\lambda_{\sf dom}$	min.	586 nm
$I_{\rm F} = 350 \text{ mA}$	46	typ.	590 nm
		max.	595 nm
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	18 nm
Viewing angle at 50% $\rm I_{_{\rm V}}$	2φ	typ.	120 °
Forward Voltage 4)	V_{F}	min.	2.00 V
$I_{\rm F} = 350 \text{ mA}$	·	typ.	2.26 V
		max.	2.60 V
Reverse voltage (ESD device)	V _{R ESD}	min.	45 V
Reverse voltage ²⁾ I _R = 20 mA	V_R	max.	1.2 V
		4	0.516.134
Real thermal resistance junction/solderpoint 5)	$R_{thJSreal}$	typ.	6.5 K / W
		max.	11.0 K / W
Electrical thermal resistance junction/solderpoint 5)	$R_{thJS\;elec.}$	typ.	5.6 K / W
with efficiency η_e = 14 %		max.	9.5 K / W



Brightness Groups

Group	Luminous Flux 1) I _E = 350 mA	Luminous Flux 1) I _E = 350 mA	Luminous Intensity ⁶⁾ I _F = 350 mA	
	min. Φ _V	$\stackrel{\scriptscriptstyler}{max}$. $\Phi_{_{_{\!$	typ.	
HZ	39 lm	45 lm	14 cd	
JX	45 lm	52 lm	16 cd	
JY	52 lm	61 lm	19 cd	
JZ	61 lm	71 lm	22 cd	
KX	71 lm	82 lm	25 cd	

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ I _F = 350 mA min. V _F	Forward Voltage ⁴⁾ I _F = 350 mA max. V _F	
J3	2.00 V	2.15 V	
M3	2.15 V	2.30 V	
Q3	2.30 V	2.45 V	
T3	2.45 V	2.60 V	

Wavelength Groups

Group Dominant Wavelength 3)		Dominant Wavelength 3)	
	$I_{F} = 350 \text{ mA}$	I _F = 350 mA	
	min.	max.	
	$\lambda_{\sf dom}$	λ_{dom}	
4	586 nm	589 nm	
5	589 nm	592 nm	
6	592 nm	595 nm	



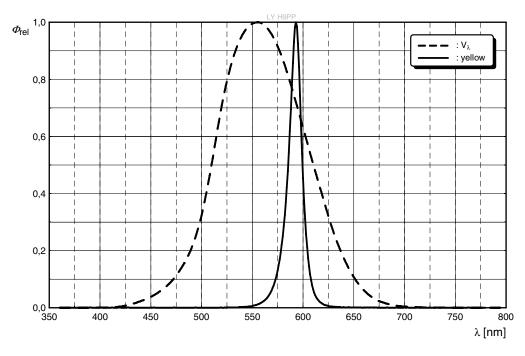
Group Name on Label

Example: HZ-4-J3

Brightness	Wavelength	Forward Voltage	
H7	4	.13	

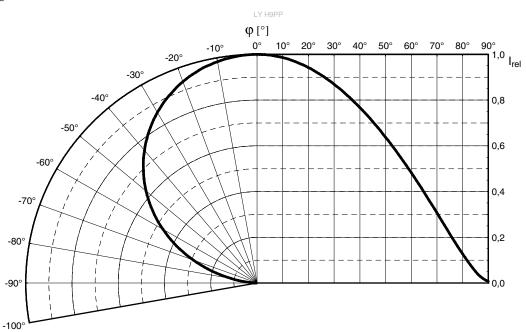
Relative Spectral Emission 6)

 Φ_{rel} = f (λ); I $_F$ = 350 mA; T $_S$ = 25 °C



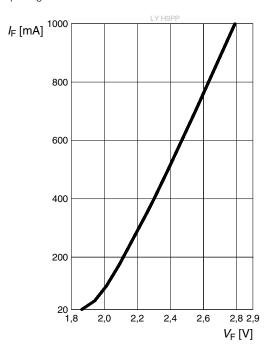
Radiation Characteristics 6)

 $I_{rel} = f(\phi); T_S = 25 °C$



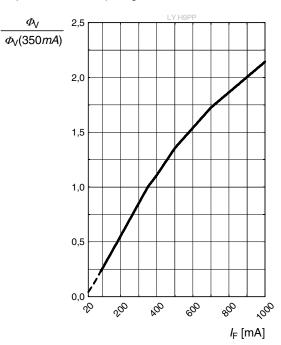
Forward current 6), 7)

$$I_F = f(V_F); T_S = 25 \text{ }^{\circ}\text{C}$$



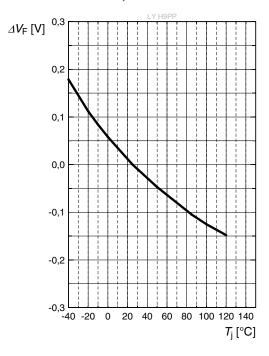
Relative Luminous Flux 6), 7)

$$\Phi_{V}/\Phi_{V}(350 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$$



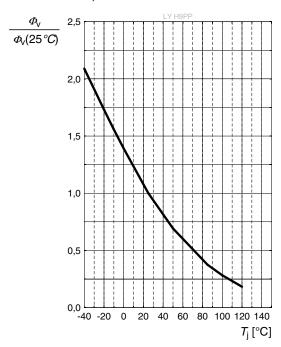
Forward Voltage 6)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25~^{\circ}C) = f(T_{_j}); I_{_F} = 350~mA$$



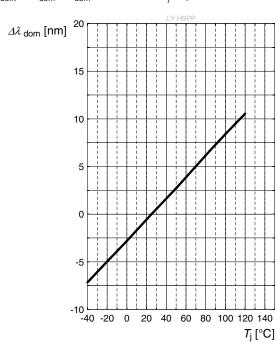
Relative Luminous Flux 6)

$$\Phi_{V}/\Phi_{V}(25 \text{ °C}) = f(T_{i}); I_{F} = 350 \text{ mA}$$



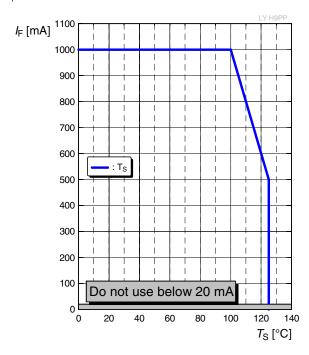
Dominant Wavelength 6)

$$\Delta \lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}} (25 \text{ °C}) = \text{f(T}_{\text{j}}); \text{ I}_{\text{F}} = 350 \text{ mA}$$



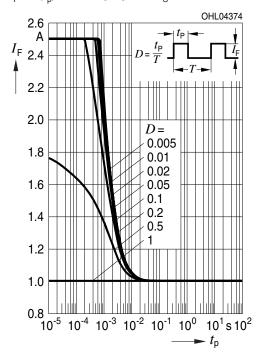
Max. Permissible Forward Current

 $I_{\scriptscriptstyle F} = f(T)$



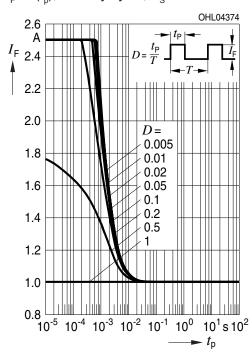
Permissible Pulse Handling Capability

 $I_{_{\rm F}}$ = f($t_{_{
m D}}$); D: Duty cycle; $T_{_{
m S}}$ = 25 °C



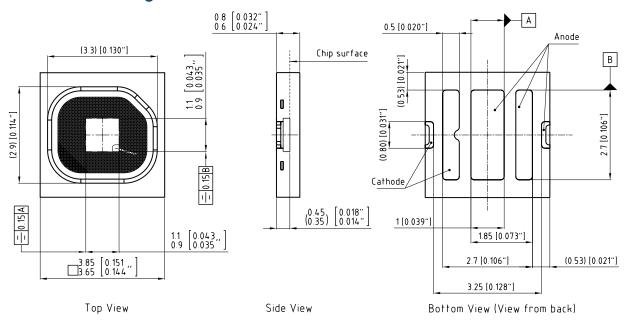
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; D: Duty cycle; $T_S = 85$ °C





Dimensional Drawing 8)



C67062-A0092-A1-06

Further Information:

Approximate Weight: 25.0 mg

Package marking: Cathode

Corrosion test: Class: 3B

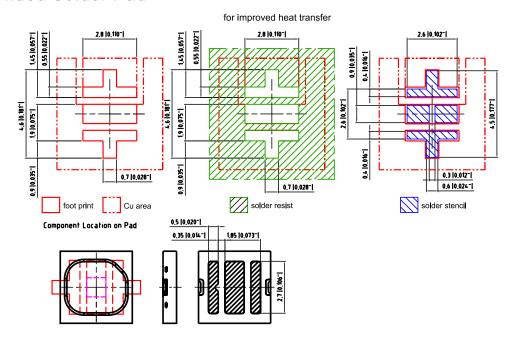
Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC

60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the

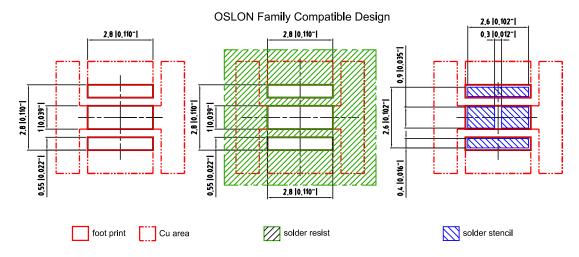
Chip.

Recommended Solder Pad 8)



E062.3010.161-01

Recommended Solder Pad 8)



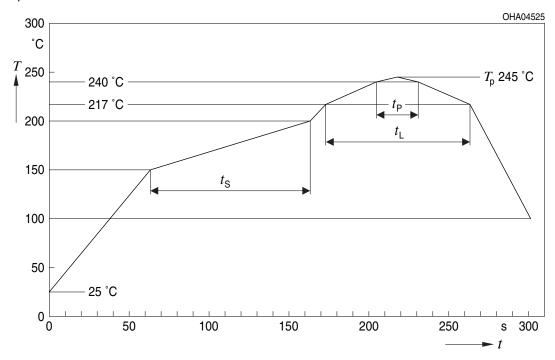
E062.3010.160-02

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. In case the PCB layout of the application is intended to be used with other OSLON derivates or in future developed OSLON derivates, the heat sink must not be electrically connected to anode or cathode solder pad because of possible chip inverted polarity. Package not suitable for ultra sonic cleaning. To ensure a high solder joint reliability and to minimize the risk of solder joint cracks, the customer is responsible to evaluate the combination of PCB board and solder paste material for his application.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



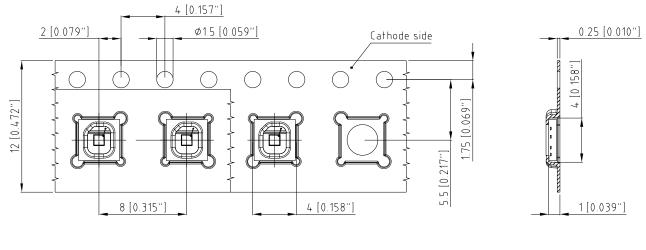
K/s
S
K/s
°C
S
°C
S
K/s
S

All temperatures refer to the center of the package, measured on the top of the component

 $^{^{\}star}$ slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



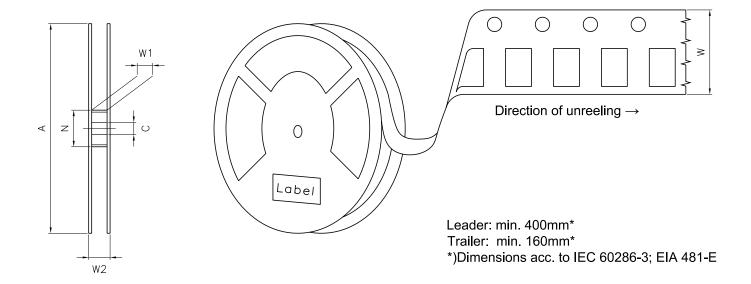
Taping 8)



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Tape and Reel 9)

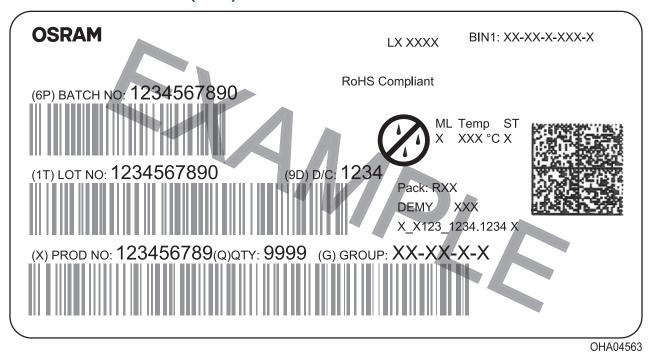


Reel Dimensions

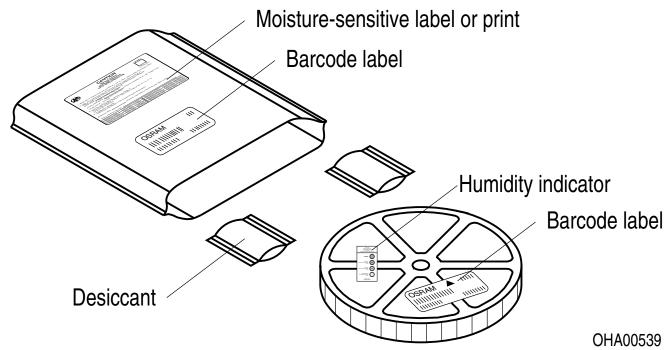
Α	W	N_{\min}	W_1	$W_{2\text{max}}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000



Barcode-Product-Label (BPL)



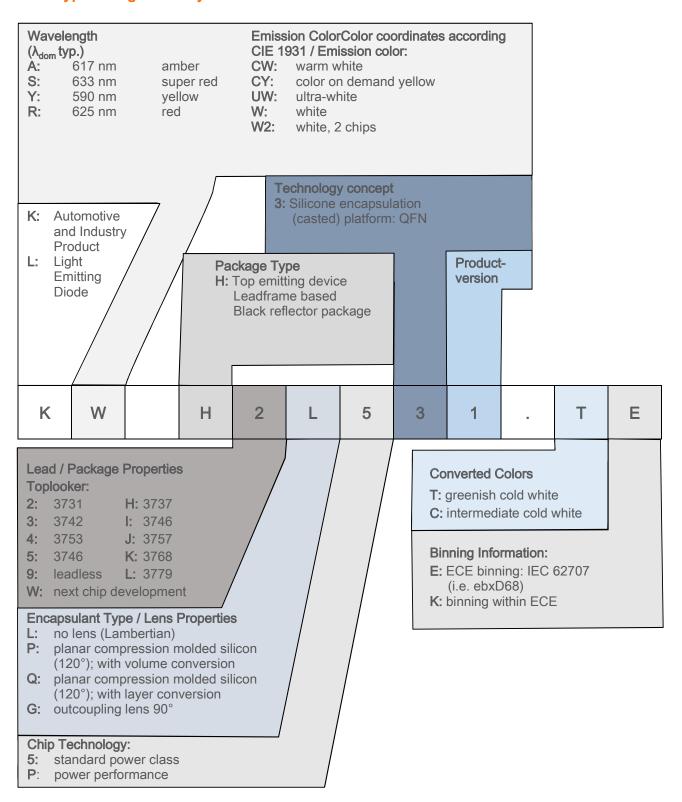
Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k =
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).
- 5) **Thermal Resistance:** Rth max is based on statistic values (6σ) .
- 6) Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- 9) Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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Revision	Revision History			
Version	Date	Change		
1.10	2020-01-30	Features		
		Further Information		
		Recommended Solder Pad		
		Reel Dimensions		
		Schematic Transportation Box		
		Dimensions of Transportation Box		
		Type Designation System		
		Notes		
		Disclaimer		
		Glossary		
1.11	2021-02-19	Notes		
		Glossary		
		Not for new design		
1.12	2022-12-14	New Layout		
		Applications		
		Discontinued		

Discontinued



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